

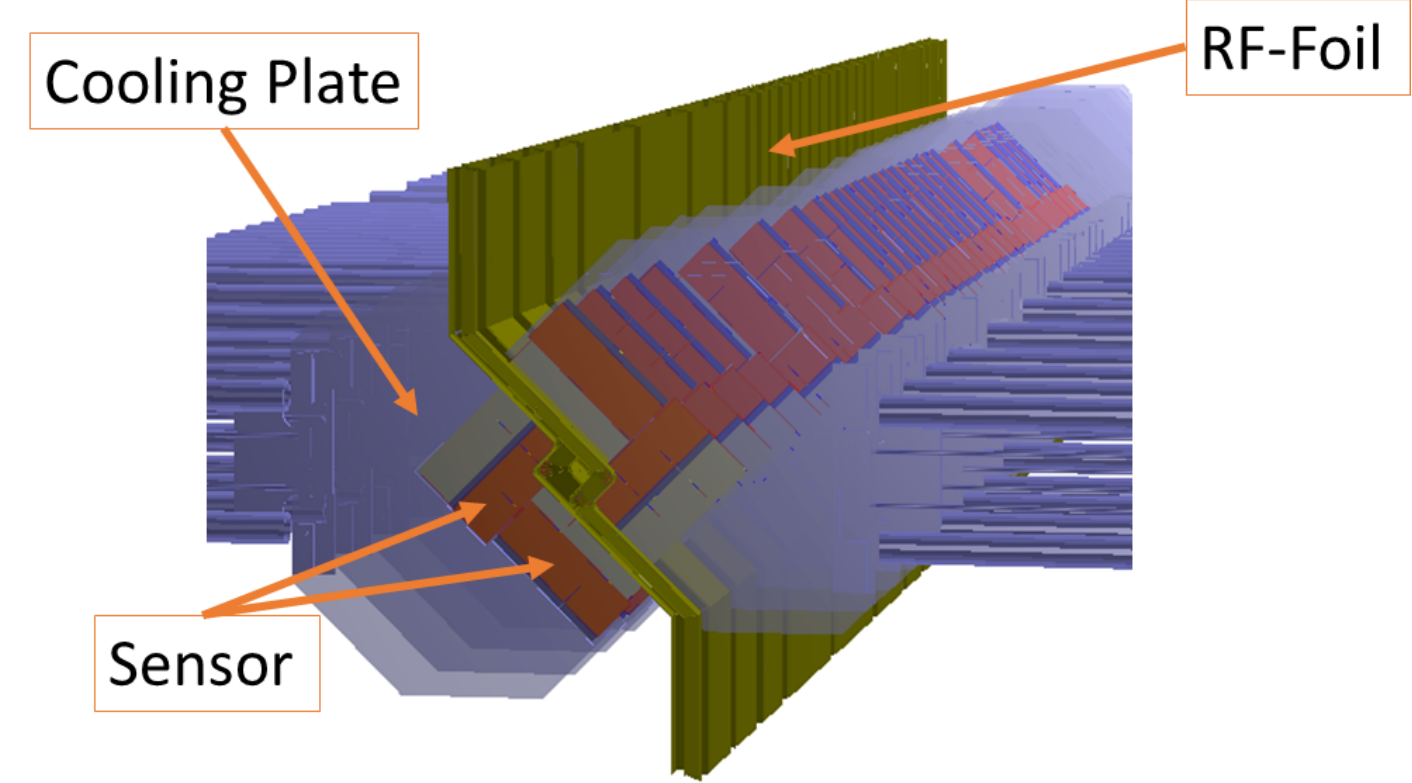
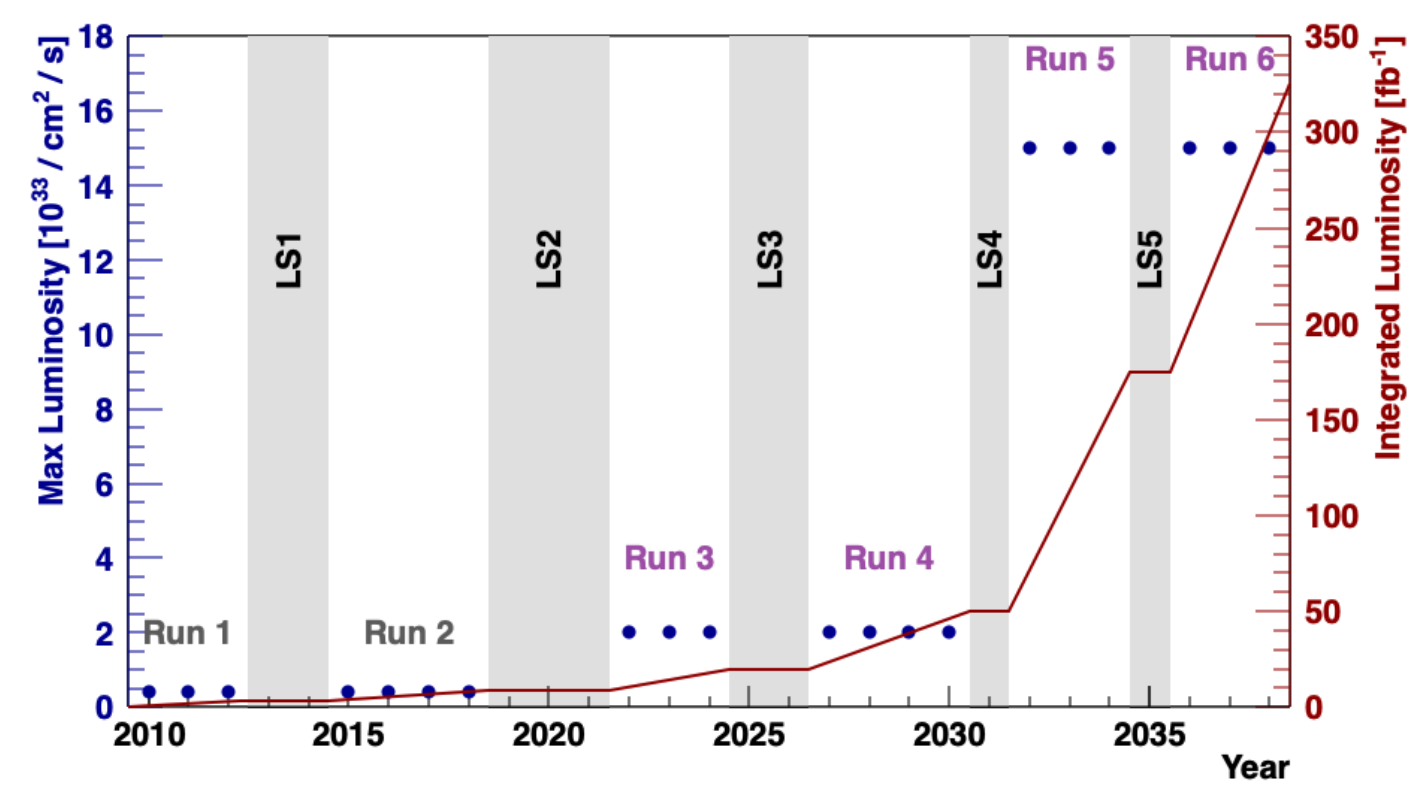
Vertex Locator (VELO) Upgrade II [1]

• To collect 300 fb^{-1} at a luminosity of $16 \times 10^{33} \text{ cm}^{-2}/\text{s}$ **LHCb Upgrade II** will see **7.5** times higher occupancy and **6** times higher fluence than in Run 3/4.

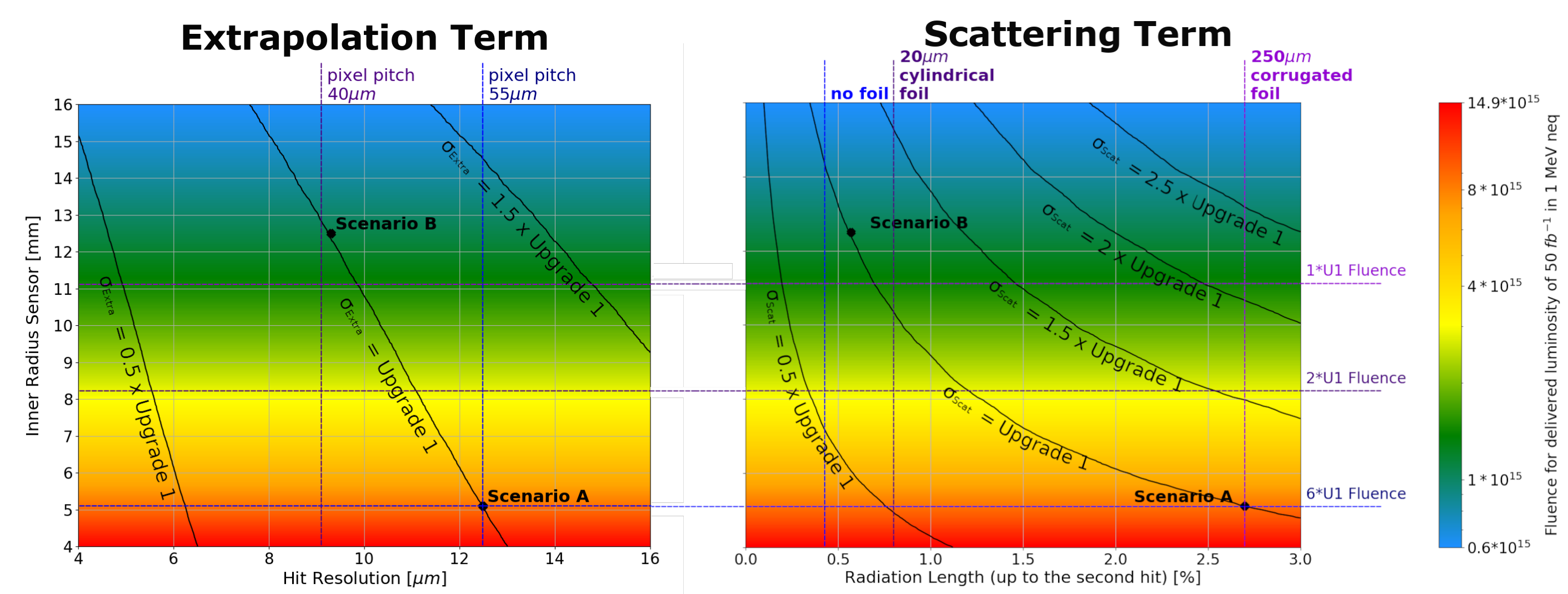
• The Vertex Locator (VELO) is an array of hybrid silicon pixel detectors surrounding the interaction point

• The detector modules operate in a secondary vacuum separated from the primary vacuum by a thin aluminium foil (RF foil)

• Mean number of vertices per event from 5 to 42 \rightarrow higher track density



Detector Layout



The impact parameter resolution approximation ($\sigma_{IP} = \sigma_{extrap} \oplus \sigma_{scat}/p_T$) for the extrapolation and multiple scattering terms

• The IP resolution can be approximated as a function of the minimal distance to the beam line, the amount of traversed material and the single hit resolution

• The Upgrade I layout (sensors at 5.1 mm from the beam line) imposes challenging requirements in terms of radiation hardness and data rate

• Radiation damage and cluster occupancy are roughly proportional to r^{-2}

• If we move from current layout (**Scenario A**) to **Scenario B** we have to reduce the material budget and improve pixel resolution.

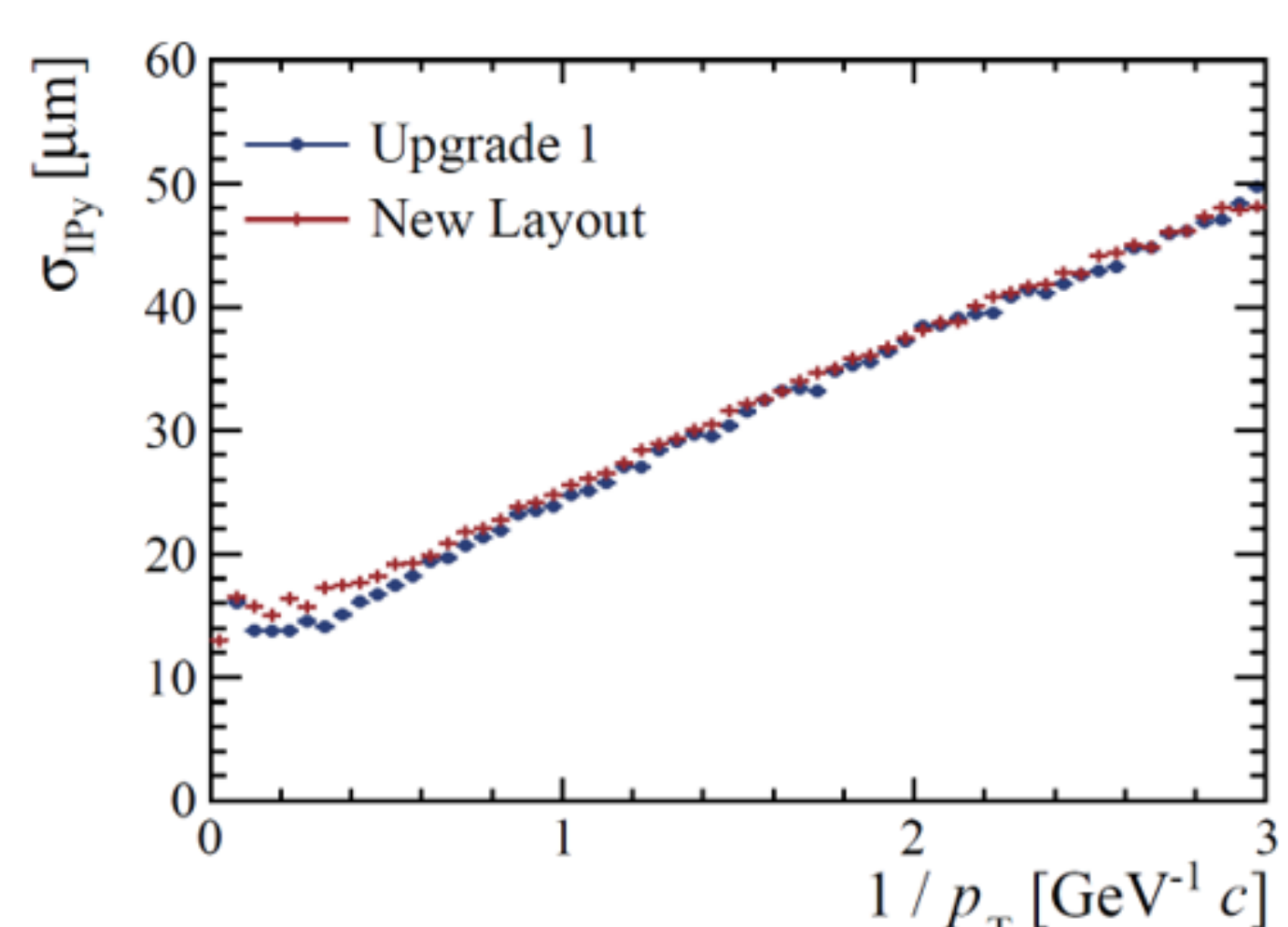
• Same IP resolution can be achieved with a pixel resolution of $9 \mu\text{m}$ and $20 \mu\text{m}$ thick cylindrical foil

• To decrease the size of the detector in Scenario B:

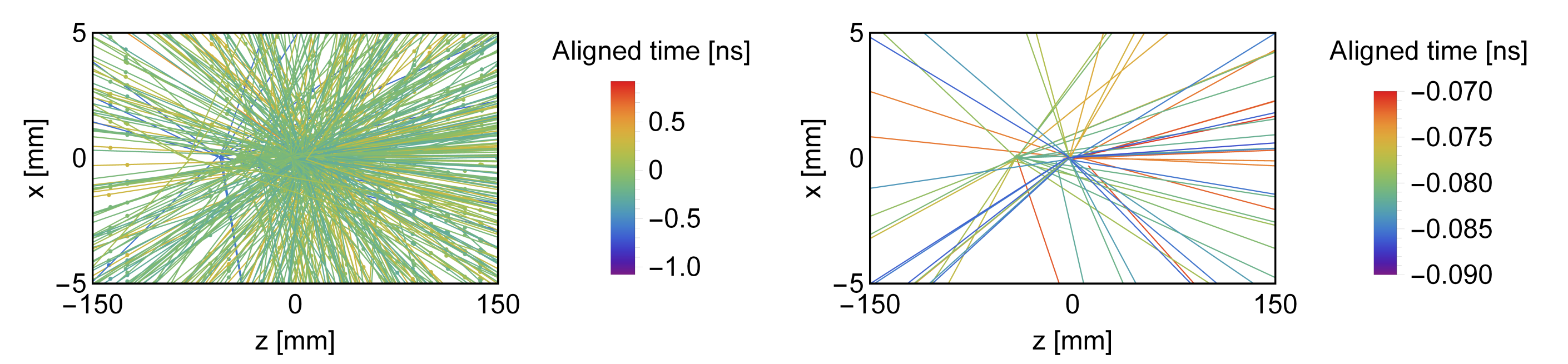
- Reduce maximum first hit radius by changing shape of inner hole
- Move sensors located further away from the interaction point closer to the beam
- Reduce acceptance from $\eta < 5$ to $\eta < 4.8$

Requirement	Scenario A	Scenario B
TID Lifetime [MGy]	> 28	> 5
Sensor+ASIC Timestamp per Hit [ps]	≤ 50	≤ 50
Hit Efficiency [%]	≥ 99	≥ 99
Power per Pixel [μW]	≤ 23	≤ 14
Pixel Rate Hottest Pixel [kHz]	> 350	> 40
Max Discharge Time [ns]	< 29	< 250
Bandwidth per ASIC of 2 cm^2 [Gb/s]	> 250	> 94
Minimum Sensor Distance from Beam [mm]	5.1	12.5
Mean Pixel Resolution [μm]	12.5	9
RF Foil [μm]	180	20
	corrugated	cylindrical
Length of the Detector [cm]	80	up to 140

• Scenarios in between are also possible: Layout with sensor position at 9.5 mm, $10.5 \mu\text{m}$ pixel resolution and a cylindrical foil with $20 \mu\text{m}$ thickness at 8.6 mm



Timing



Upgrade II track density for a 2000 ps time window (left) and a 20 ps time window (right)

- Upgrade II will lead to an drastic decrease in primary vertex reconstruction efficiency and an increase in the number of falsely reconstructed vertices
- Adding timing with at least 20 ps time resolution per track is needed to compensate, which can be achieved by either a 4D VELO or separate timing planes
- 50 ps time resolution in each hit (4D VELO) results in 20 ps time resolution per track

• Separate timing planes considered:

- Big timing planes at the end to cover the full VELO acceptance
- Smaller end caps with reduced acceptance
- End caps + barrel to recover the reduced acceptance due to small end caps

- At least 3 planes in each direction for hit rejection
- Each plane has to have at least 25 ps time due to the limited number of planes, but only a spatial resolution of around $100 \mu\text{m}$ is needed
- Timing planes suffer an additional error due to different t.o.f. for low momentum particles

• 3 sensor types are considered for 4D VELO and timing planes:

– **Thin Planar Sensors:**

- Radiation hard up to $1.6 \times 10^{17} \text{ MeV n}_{eq}/\text{cm}^2$
- low signal

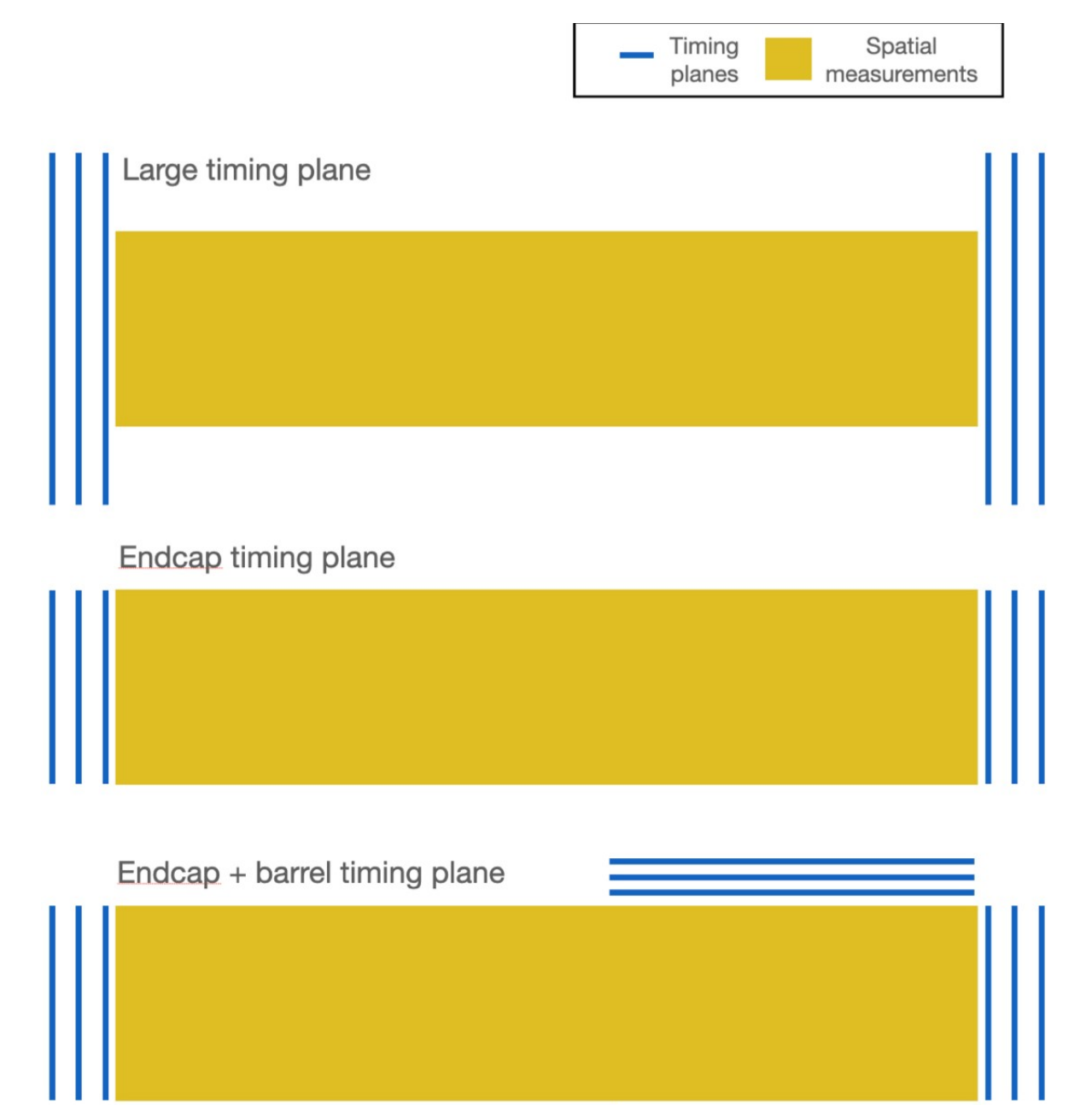
– **Low Gain Avalanche Diode:**

- fast and sizeable signal
- radiation hard only up to $2 \times 10^{15} \text{ MeV n}_{eq}/\text{cm}^2$

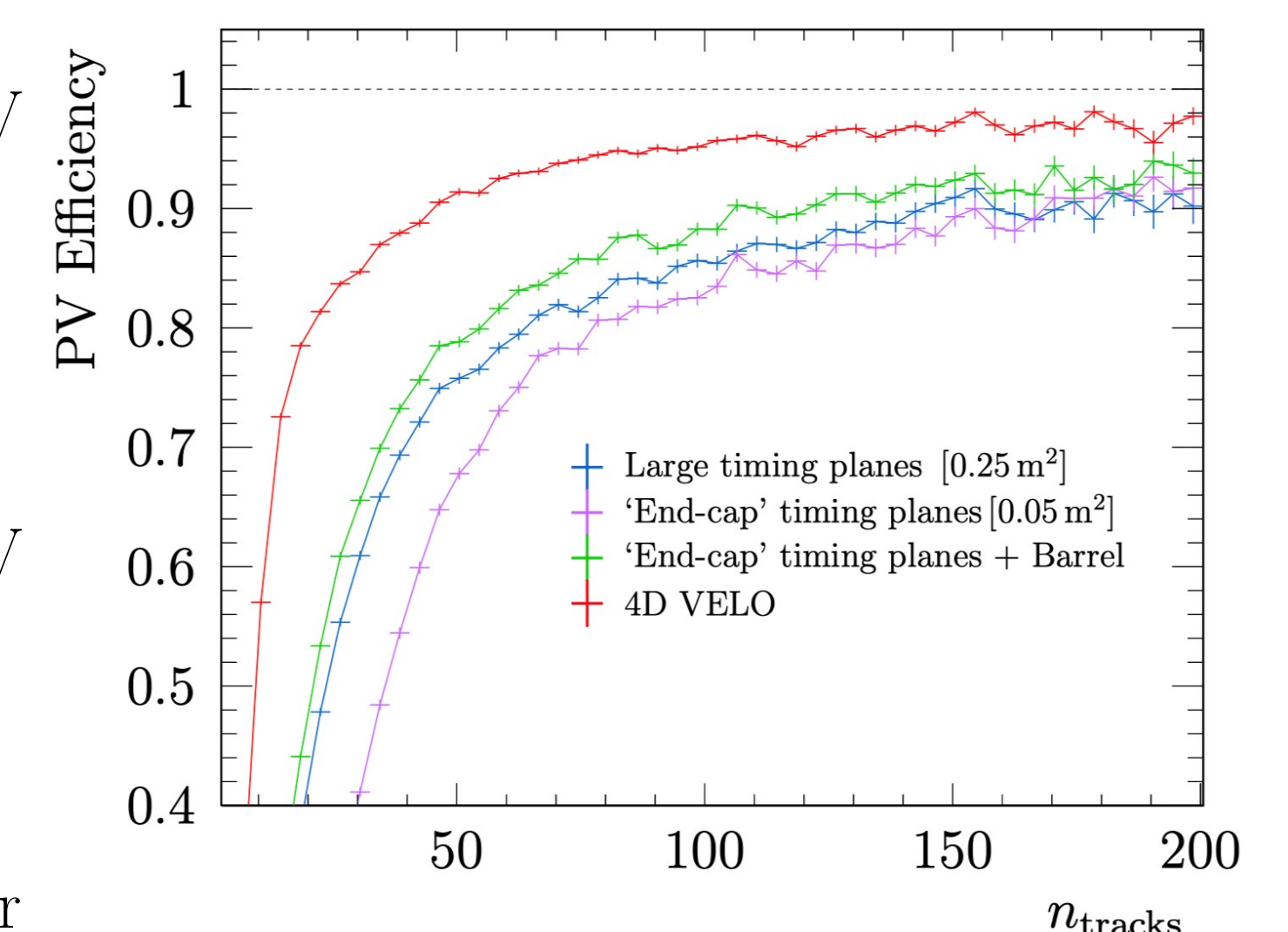
– **3D:**

- radiation hard, fast collection time
- inefficient volumes at the columns or trenches

- On hit timing with 50 ps resolution is sufficient to recover reconstruction and is preferred over dedicated timing planes



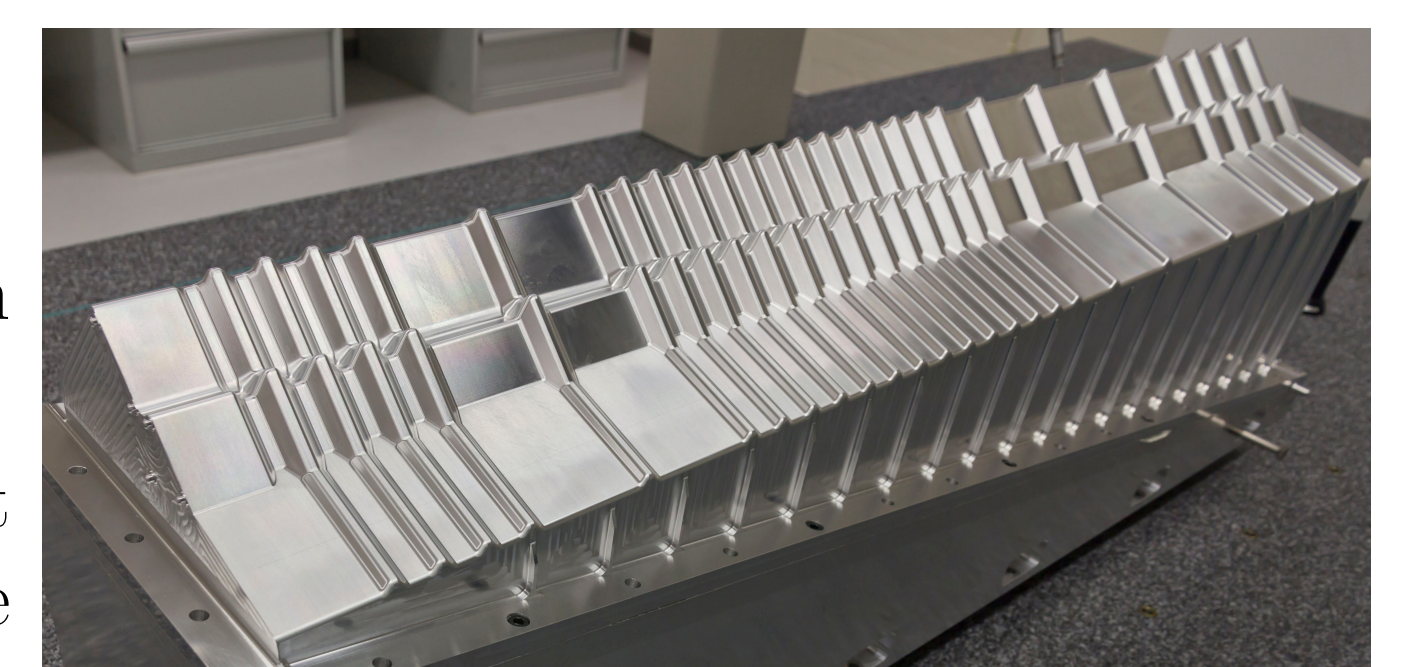
Schematics of possible timing plane solutions



Primary vertex reconstruction efficiency as a function of multiplicity for different timing solutions

Material Budget

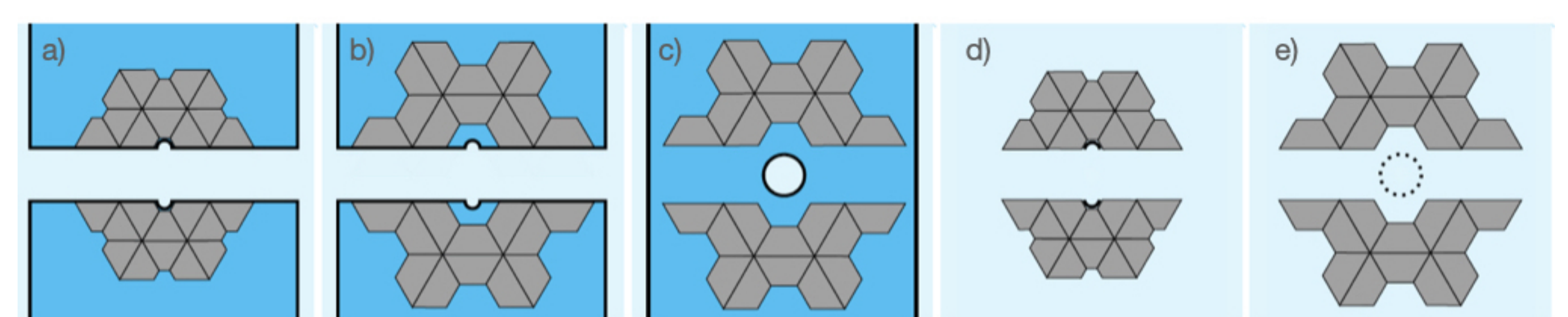
- Material before first hit most important \rightarrow RF foil
- Current corrugated foil hard to thin down more \rightarrow Cylindrical foil or wire frame
- If the inner radius is increased to at least 8.6 mm it can be constructed out of a single piece, without problems during injection



Upgrade 1 corrugated RF foil [3]

• Requirements for new foils:

- Mechanical stability
- Conducting the beam current
- Containing the primary vacuum (if vacuum is still separated)
- Shield sensors from wake field



Schematics of possible RF foil shapes

References

- [1] <https://cds.cern.ch/record/2653011/files/LHCb-PUB-2019-001.pdf>
- [2] <https://cds.cern.ch/record/1624070/files/LHCb-TDR-013.pdf>
- [3] https://www.nikhef.nl/pub/departments/mt/projects/lhcb-vertex/production/UpgradeRFbox/IMG_9824.jpg